imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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Contact us

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225mW SMD Switching Diode

FEATURES

- Fast switching speed
- Surface mount device type
- Moisture sensitivity level 1
- Matte Tin (Sn) lead finish with Nickel (Ni) underplate
- Pb free version and RoHS compliant
- Packing code with suffix "G" means
- green compound (halogen-free)

MECHANICAL DATA

- Case: SOT-23 small outline plastic package
- Terminal: Matte tin plated, lead free., solderable
- per MIL-STD-202, Method 208 guaranteed
- High temperature soldering guaranteed : 260°C/10s
- Weight: 8 ± 0.5 mg



SOT-23



L CHARACTERI	STICS (T _A =25°C un	less otherwise noted)	
	SYMBOL	VALUE	UNIT
	PD	225	mW
	V _{RRM}	250	V
	I _{FRM}	625	mA
	Ι _Ο	200	mA
(Note 1)	I _{FSM}	1	Α
(Note 2)	R _{θJA}	500	°C/W
	T _J , T _{STG}	-55 to +150	°C
	(Note 1)	SYMBOL P _D V _{RRM} I _{FRM} I _O (Note 1) I _{FSM} (Note 2)	$\begin{array}{c c c c c c c c } & & P_D & & 225 \\ \hline & V_{RRM} & & 250 \\ \hline & I_{FRM} & & 625 \\ \hline & I_O & & 200 \\ \hline & & I_O & & 200 \\ \hline & & & I_{FSM} & & 1 \\ \hline & & & & 1 \\ \hline & & & & & 500 \\ \hline \end{array}$

Notes : 1. Test condition : 8.3 ms single half sine-wave superimposed on rated load (JEDEC method) pulse width = 1 µsec

2. Valid provided that electrodes are kept at ambient temperature

PA	SYMBOL	MIN	MAX	UNIT	
Reverse Breakdown Voltage	I _R = 100 μA	V _{R(BR)}	250	-	V
	I _F = 100 mA	N/	-	1.00	V
Forward Voltage	I _F = 200 mA	V _F	-	1.25	V
Reverse Leakage Current	V _R = 200 V	I _R	-	0.1	μA
Junction Capacitance	V _R = 1 V , f = 1.0 MHz	CJ	-	5	pF
Reverse Recovery Time	$I_F = I_R = 30 \text{mA}$, $R_L = 100 \Omega$, $I_{RR} = 1 \text{mA}$	trr	-	50	ns



RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)

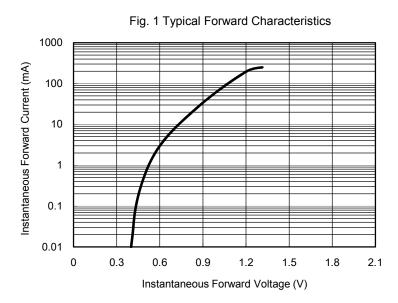
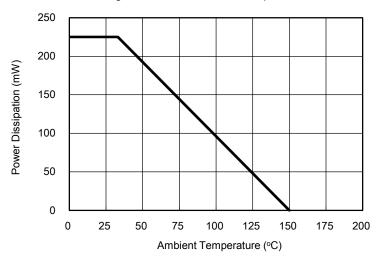
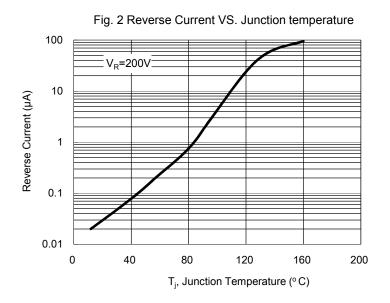


Fig. 3 Admissible Power Dissipation Curve







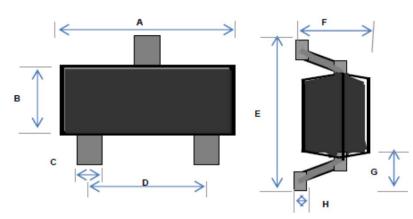
ORDERIN	ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX (Note 2)	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING	
BAS2xx	YY	RF	G	SOT-23	3K / 7" Reel	
(Note 1)	-XX	R5	G	301-23	10K / 13" Reel	

Note 1: "xx" is Device Code "1" thru "1S"

Note 2: Part No. Suffix "-xx " would be used for special requirement

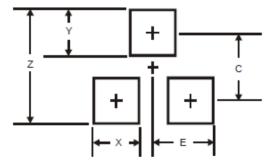
EXAMPLE					
PREFERRED P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
BAS21 RF	BAS21		RF		Multiple manufacture source
BAS21 RFG	BAS21		RF	G	Multiple manufacture source Green compound
BAS21-B0 RFG	BAS21	-В0	RF	G	Defined manufacture source Green compound
BAS21-D0 RFG	BAS21	-D0	RF	G	Defined manufacture source Green compound

PACKAGE OUTLINE DIMENSIONS



IM.	Unit (mm)		Unit (inch)		
, , , , , , , , , , , , , , , , , , , ,	Min	Max	Min	Max	
Α	2.70	3.10	0.106	0.122	
В	1.10	1.50	0.043	0.059	
С	0.30	0.51	0.012	0.020	
D	1.78	2.04	0.070	0.080	
E	2.10	2.64	0.083	0.104	
F	0.89	1.30	0.035	0.051	
G	0.55 REF		0.022	2 REF	
Н	0.10 REF		0.004	REF	

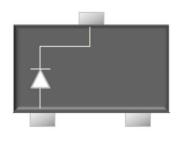
SUGGEST PAD LAYOUT



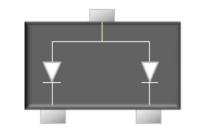
DIM.	Unit (mm)	Unit (inch)	
DIM.	Тур.	Тур.	
Z	2.8	0.110	
Х	0.7	0.028	
Y	0.9	0.035	
С	1.9	0.075	
E	1.0	0.039	



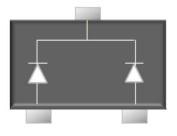
PIN CONFIGURATION



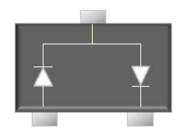
BAS21



BAS21A



BAS21C



BAS21S

MARKING

Part NO.	Marking
BAS21	JS
BAS21A	JS2
BAS21C	JS3
BAS21S	JS4



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